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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/516,621 Confirmation No. 5295
Applicant : Tatsuo TSUNEKA et al.
Filed : December 3, 2004
TC/A.U. : 1796
Examiner : William K. Cheung
Dkt. No. : SAE-036
Cust. No. : 20374

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. 1.97(c)
WITH A STATEMENT AS SPECIFIED IN 37 C.F.R. §1.97(e)

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

May 29, 2008

Sir:

The attention of the Patent and Trademark Office is hereby directed to the document listed on the attached Form PTO/SB/08. The document has been cited in an office action in a corresponding Japanese application. One copy of each of the listed document and a copy of the office action is attached.

This Information Disclosure Statement is being submitted after issuance of a first official action on the merits and expiration of the three month period following filing of the above-captioned application, but prior to issuance of a final official action or a

Notice of Allowance or an action that otherwise closes prosecution in the application.

The undersigned hereby states that each item of information contained in this statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.

Document FA is not in the English language. However, the concise explanation of the relevance of the document required under 37 C.F.R. §1.98 is believed to be satisfied by submission of an English language abstract thereof.

The document cited in the office action but not presently submitted, WO 0018827 A1, was submitted to the Office with the IDS filed June 22, 2005

No fee is required in connection with this statement.

Respectfully submitted,
KUBOVCIK & KUBOVCIK



Keiko Tanaka Kubovcik
Reg. No. 40,428

Atty. Case No. SAE-036
Crystal Gateway 3
Suite 1105
1215 South Clark Street
Arlington, VA 22202
Tel: (703) 412-9494
Fax: (703) 412-9345
KTK/JBF

U.S. Patent Appln. S.N. 10/516,621
INFORMATION DISCLOSURE STATEMENT

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Attachments: PTO/SB/08
 One Document
 Japanese Office Action